
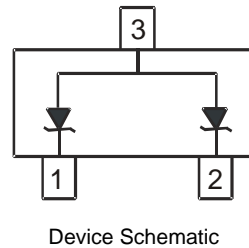


**Features**

- 300 Watts Peak Pulse Power (tp = 8x20µs)
- IEC 61000-4-2 (ESD): Air – 15kV, Contact – 8kV
- Typically Used at Computer Interface Protection, Data Line and Power Line Protection
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

**Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 
- Weight: 0.0089 grams (approximate)

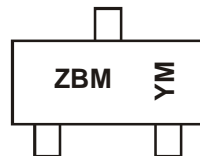


**Ordering Information** (Note 4)

Part Number	Case	Packaging
SM12-7	SOT23	3,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  2. See <http://www.diodes.com> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <http://www.diodes.com>.

**Marking Information**



ZBM = Product Type Marking Code  
 YM = Date Code Marking  
 Y = Year (ex: Z = 2012)  
 M = Month (ex: 9 = September)

Date Code Key

Year	2012	2013	2014	2015	2016	2017	2018
Code	Z	A	B	C	D	E	F

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Maximum Ratings** (@T<sub>A</sub> = 25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P <sub>PP</sub>	300	W	8/20μs, Per Fig. 3
Peak Pulse Current	I <sub>PP</sub>	12	A	8/20μs, Per Fig. 3
ESD Protection – Contact Discharge	V <sub>ESD Contact</sub>	±8	kV	Standard IEC 61000-4-2(ESD)
ESD Protection – Air Discharge	V <sub>ESD Air</sub>	±15	kV	Standard IEC 61000-4-2(ESD)
Electrical Fast Transient Current	I <sub>EFT</sub>	40	A	Standard IEC 61000-4-4(EFT)

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P <sub>D</sub>	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	500	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = 25°C unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Working Voltage	V <sub>RWM</sub>	-	-	12.0	V	-
Reverse Current (Note 6)	I <sub>R</sub>	-	-	1.0	μA	V <sub>R</sub> = V <sub>RWM</sub> = 12.0V
Reverse Breakdown Voltage	V <sub>BR</sub>	13.3	-	15.75	V	I <sub>R</sub> = 1mA
Reverse Clamping Voltage	V <sub>CL</sub>	-	-	19	V	I <sub>PP</sub> = 1A, t <sub>p</sub> = 8/20μs
Capacitance	C <sub>T</sub>	-	95	-	pF	V <sub>R</sub> = 0V, f = 1MHz, Pin 1 to 3

- Notes:
- Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at <http://www.diodes.com>.
  - Short duration pulse test used to minimize self-heating effect.

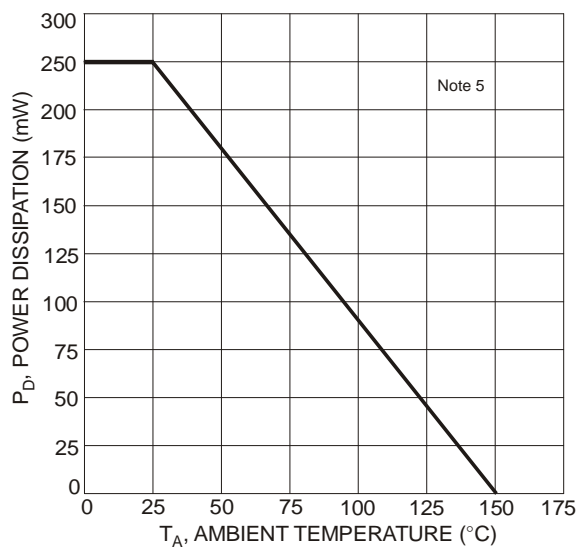


Figure 1 Power Derating Curve

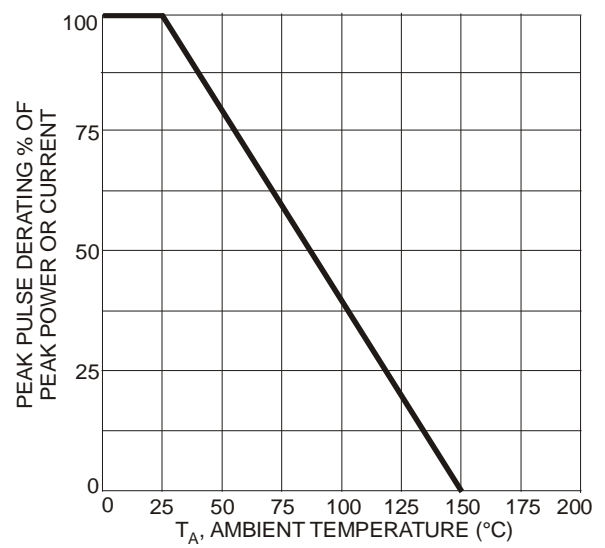
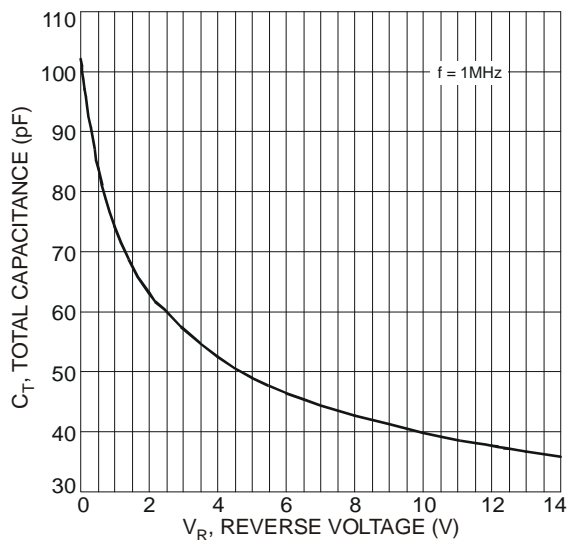
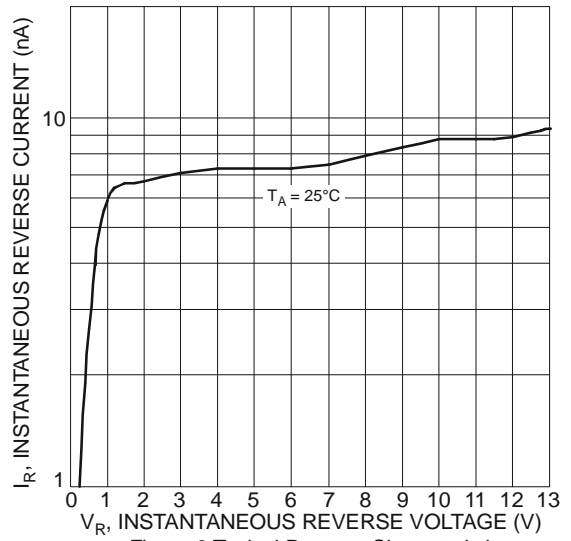
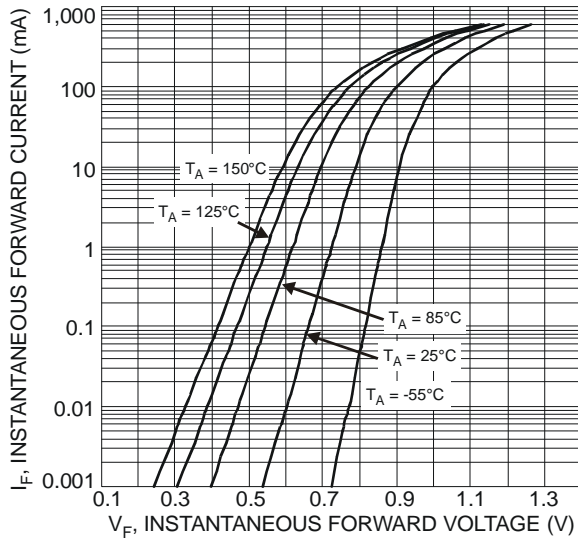
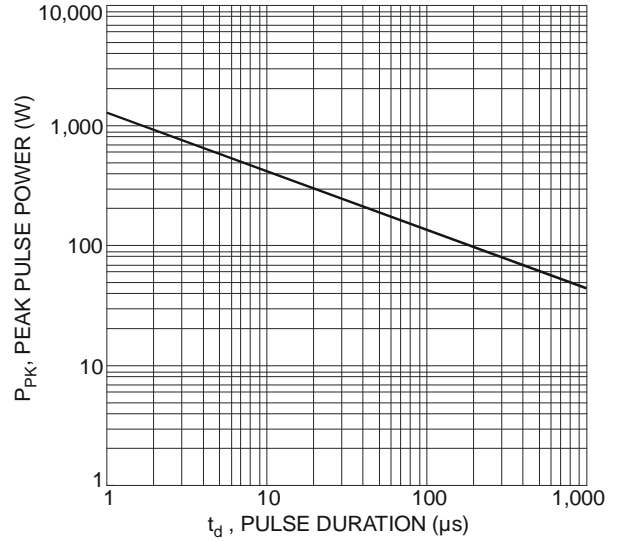
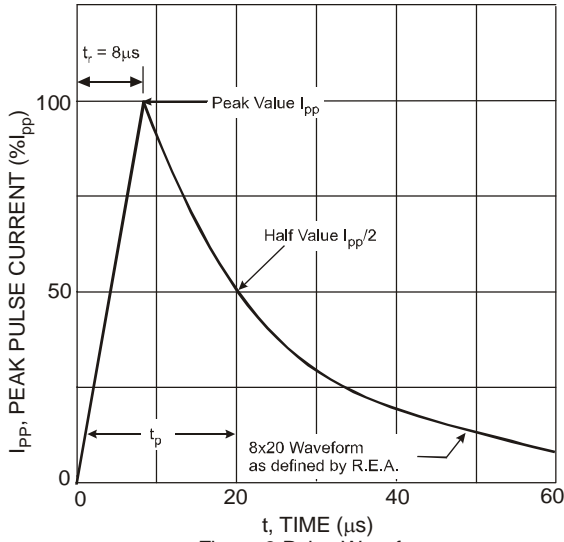
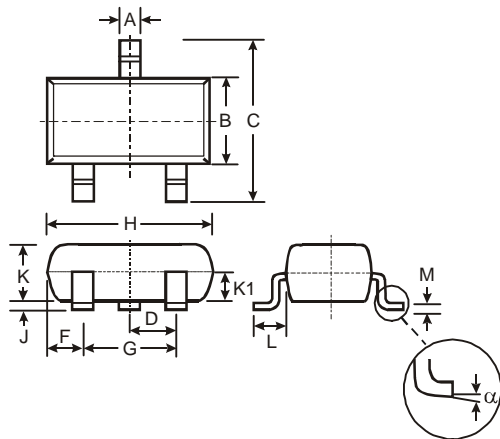


Figure 2 Power Dissipation vs. Ambient Temperature



## Package Outline Dimensions

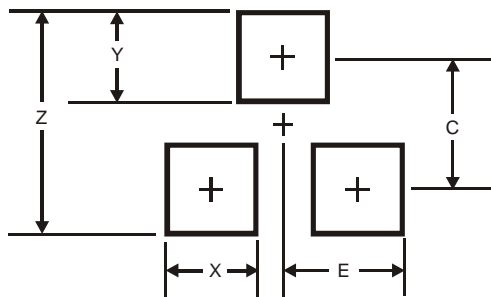
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.903	1.10	1.00
K1	-	-	0.400
L	0.45	0.61	0.55
M	0.085	0.18	0.11
α	0°	8°	-
All Dimensions in mm			

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

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